

設備名稱：Secured Wireless Access Point, 型號（型式）：FAP-221B
 Equipment name Type designation (Type)

單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
電路板總成 PCBA	—	○	○	○	○	○
金屬機構件 ME metal part	—	○	○	○	○	○
塑膠機構件 ME plastic part	○	○	○	○	○	○
配件(例: 壁掛 螺絲等) Accessory (SCREW, etc.)	—	○	○	○	○	○

備考 1. “超出 0.1 wt %” 及 “超出 0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage of presence condition.

備考 2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence condition.

備考 3. “—” 係指該項限用物質為排除項目。
 Note 3: The “—” indicates that the restricted substance corresponds to the exemption.